Techniques for effective searching with IEEE Xplore

Eszter Lukács

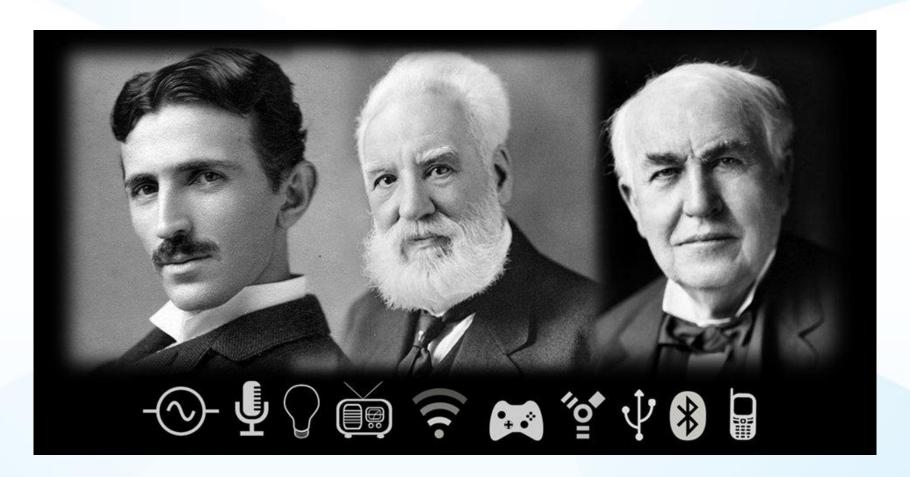
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1884: Where we came from



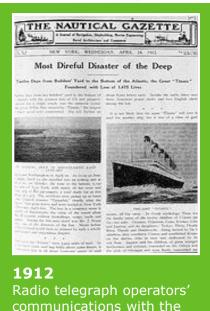


1912: The Institute of Radio Engineers is founded





1901
Guglielmo Marconi and
George Kemp with
equipment used in
transatlantic wireless
telegraphy



communications with the sinking Titanic demonstrated the power of radio



1922
Triode vacuum tube
inventor Lee de Forest
with a radio



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The New York Times.

THE REALISES.

We. 148-70. 386

MEN TORK TURNOUT, APRIL 14, 1022-PRINCE PARK

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TITANIC SINKS FOUR HOURS AFTER HITTING ICEBERG; 866 RESCUED BY CARPATHIA, PROBABLY 1250 PERISH; ISMAY SAFE, MRS. ASTOR MAYBE, NOTED NAMES MISSING

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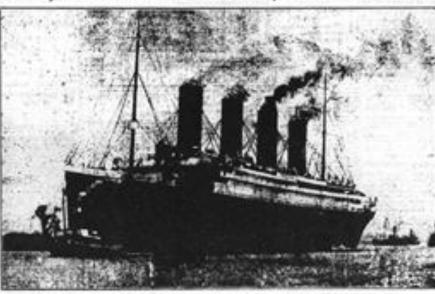
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ACTION REPORT TO THE WAY AND ACTION ACTION AND ACTION ACTION AND ACTION ACTION AND ACTION ACTION

CAPE BACK, N. P., April 10. The Washing live (1), april



Marconi Biographical Details

- Disaster led to the "International Radio-Telegraphic Convention," London, July 1912.
- Established regulations and procedures for use of wireless services in maritime disasters, including "SOS."
- Followed by "Safety at Sea" Conference, London, November 1913. Sweeping regulations put into place.
- Tragedy was the "jump start" of the wireless, radio, and electronics industry that we know today.
- Titanic survivors present Marconi gold medal in gratitude for Marconi's wireless installation on board the Titanic credited for saving their lives.
- Britain's postmaster-general summed up, "Those who have been saved, have been saved through one man, Mr. Marconi...and his marvelous invention."



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L'History Activity Committee è stato istituito dalla Sezione Italiana nel 2016 per sviluppare attività di promozione della storia della tecnologia elettrica e, in particolare, per incentivare proposte italiane di IEEE Milestones. La riunione è servita prima di tutto per una migliore conoscenza

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December 2015





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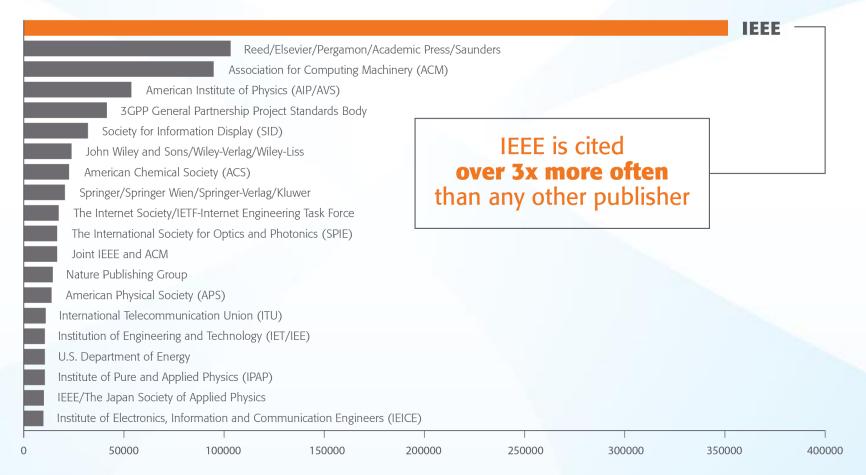


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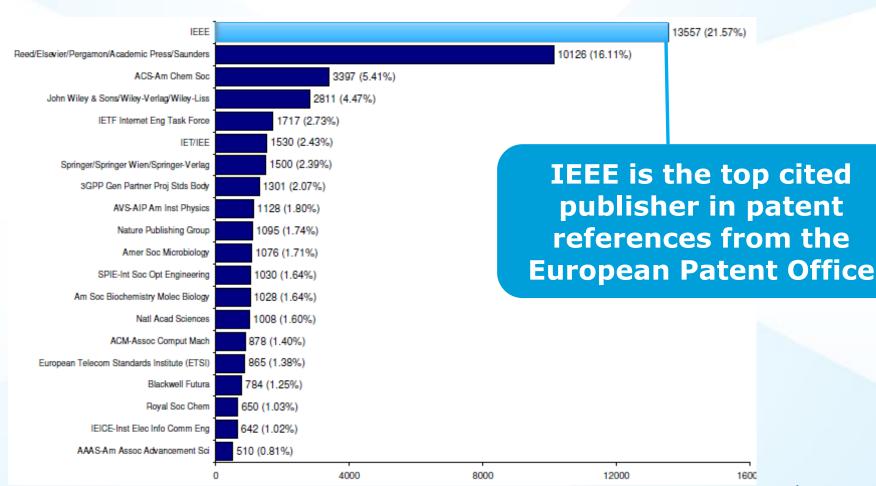


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Information storage

Measuring, testing, and control

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- IEEE Communications Standards Magazine
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- Intelligent Systems Engineering (ICISE), 2016 International Conference on
- Intelligent Transportation Engineering (ICITE), 2016 IEEE International Conference on
- Mechatronics, Adaptive and Intelligent Systems (MAIS), 2016 IEEE Conference on
- Power Electronics, Intelligent Control and Energy Systems (ICPEICES), 2016 IEEE 1st International Conference on
- The Science of Electrical Engineering (ICSEE), 2016 IEEE International Conference on



Popular IEEE Standards

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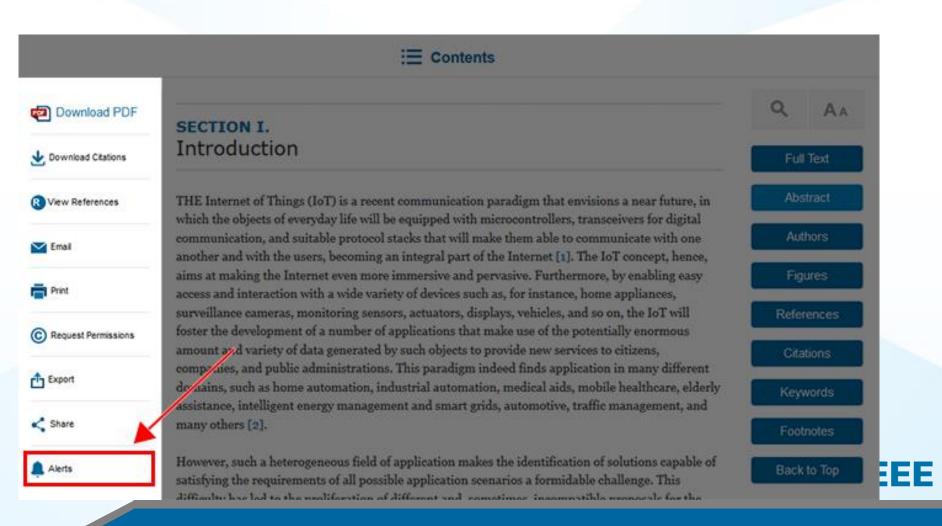
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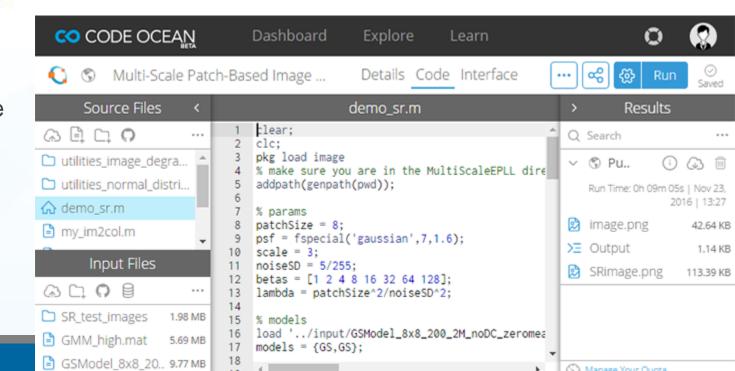
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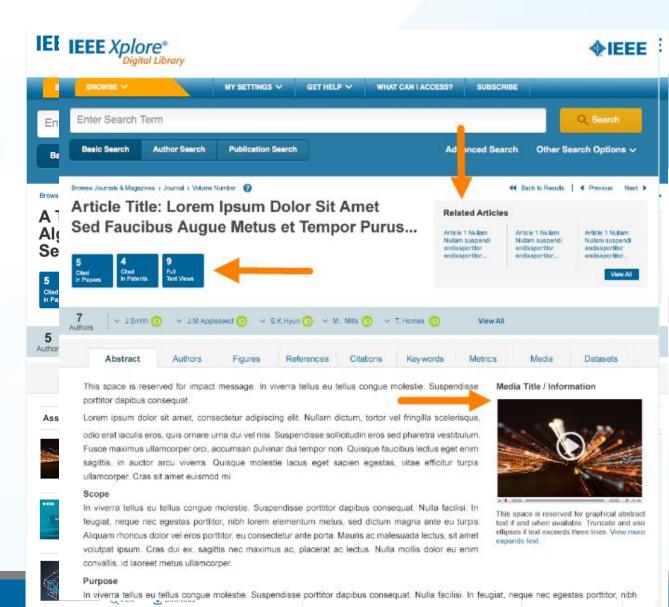


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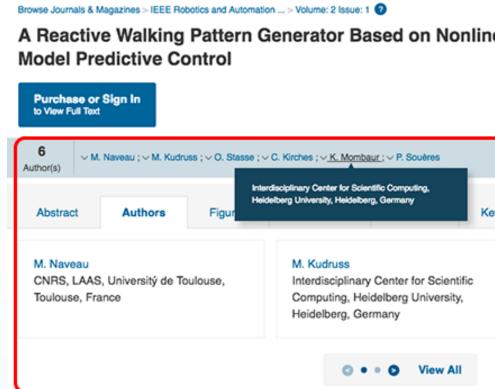
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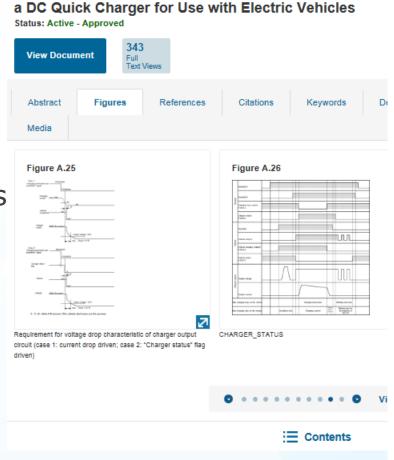
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- 1. Scope
- 2. Normative references
- 3. Definitions
 - 3.1 Vehicle terms
 - 3.2 Charger terms
 - 3.3 Communications terms
- 4. Conventions
 - 4.1 General
 - 4.2 Binary representation
 - 4.3 Hexadecimal representation
 - 4.4 Decimal representation
 - 4.5 Transmission sequence
 - 4.6 Formulas
 - 4.7 Units of measure

5. Common requirements

- 5.1 Background
- 5.2 Requirements

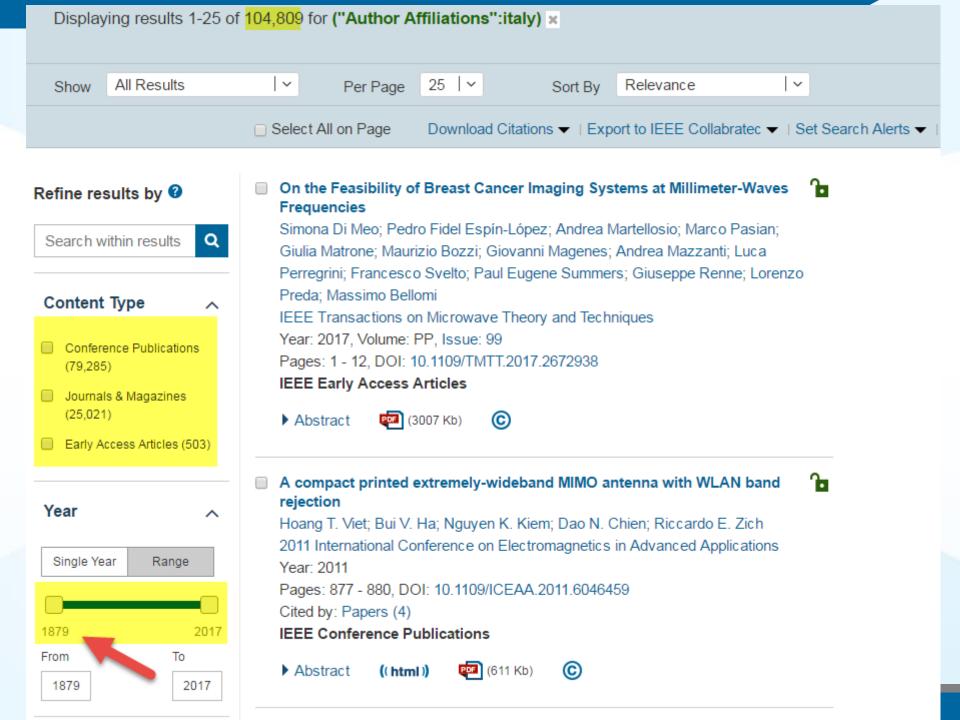
Annex A CHAdeMO specifications

- A.1 Scope of application
- A.2 Vehicle coupler
- A.3 Installation conditions and main specifications
- A.4 Requirements for basic design of the charger and the vehicle



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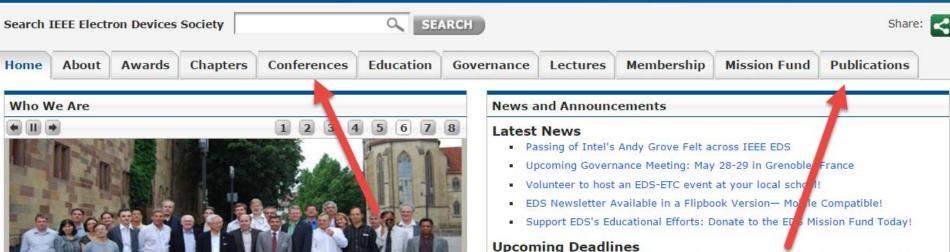
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Aims & Scope

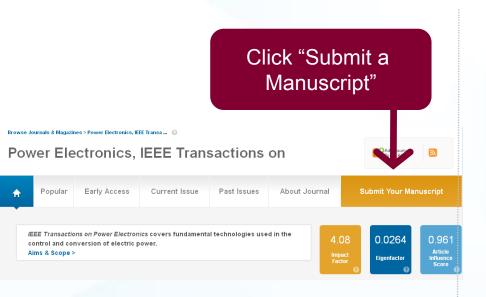
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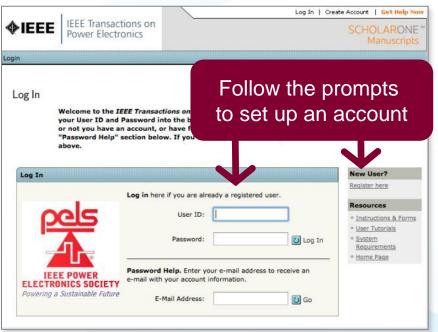
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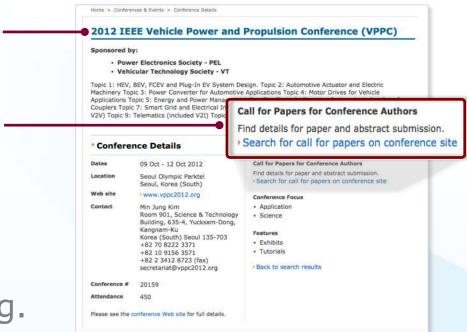


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Structure



Paper Structure

Elements of a manuscript

Title

Abstract

Keywords

Introduction

Methodology

Results/Discussions/Findings

Conclusion

References





Paper Structure Title

An effective title should...

- •Answer the reader's question: "Is this article relevant to me?"
- •Grab the reader's attention
- •Describe the content of a paper using the fewest possible words
 - Is crisp, concise
 - Uses keywords
 - Avoids jargon





Paper Structure

Good vs. Bad Title

A Human Expert-based Approach to Electrical Peak Demand Management

VS

A better approach of managing environmental and energy sustainability via a study of different methods of electric load forecasting



Paper Structure

Good vs. Better Title

An Investigation into the Effects of Residential Air-Conditioning Maintenance in Reducing the Demand for Electrical Energy

VS

"Role of Air-Conditioning Maintenance on Electric Power Demand"



Paper Structure Abstract

Why you did A "stand alone" condensed version of the article No more than 250 words; What you did written in the past tense Uses keywords How the results and index terms were useful, important & move the field forward Why they're useful & important & move the field forward



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- 3) Written as **one paragraph**, and should **not contain** displayed **mathematical equations or tabular material**.
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Paper Structure

Good vs. Bad Abstract

The objective of this paper was to propose a human expert-based approach to electrical peak demand management. The proposed approach helped to allocate demand curtailments (MW) among distribution substations (DS) or feeders in an electric utility service area based on requirements of the central load dispatch center. Demand curtailment allocation was quantified taking into account demand response (DR) potential and load curtailment priority of each DS, which can be determined using DS loading level, capacity of each DS, customer types (residential/commercial) and load categories (deployable, interruptible or critical). Analytic Hierarchy Process (AHP) was used to model a complex decision-making process according to both expert inputs and objective parameters. Simulation case studies were conducted to demonstrate how the proposed approach can be implemented to perform DR using real-world data from an electric utility. Simulation results demonstrated that the proposed approach is capable of achieving realistic demand curtailment allocations among different DSs to meet the peak load reduction requirements at the utility level.

Vs

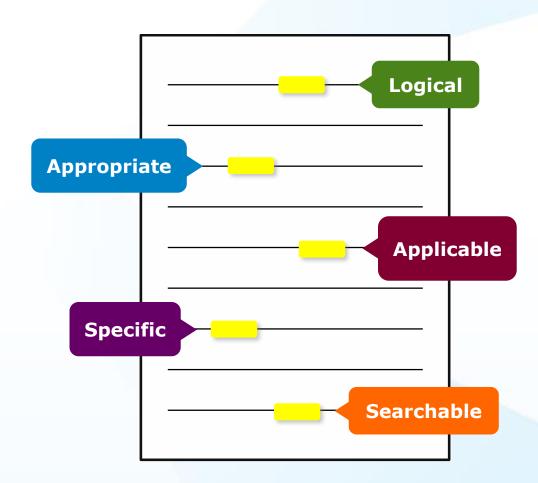
This paper presents and assesses a framework for an engineering capstone design program. We explain how student preparation, project selection, and instructor mentorship are the three key elements that must be addressed before the capstone experience is ready for the students. Next, we describe a way to administer and execute the capstone design experience including design workshops and lead engineers. We describe the importance in assessing the capstone design experience and report recent assessment results of our framework. We comment specifically on what students thought were the most important aspects of their experience in engineering capstone design and provide quantitative insight into what parts of the framework are most important.

First person, present tense
No actual results, only describes the organization of the paper



Paper Structure Keywords

Use in the Title and Abstract for enhanced Search Engine Optimization





IEEE Keywords

Bit rate, Decoding, Encoding, Parallel processing, Video coding

Authors Keywords

High Efficiency Video Coding (HEVC), parallel programming, video coding

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parallel processing, video coding

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Paper Structure Introduction

- A description of the problem you researched
- It should move step by step through, should be written in present tense:

Generally known information about the topic

Prior studies'
historical
context to your
research

Your hypothesis and an overview of the results

How the article is organized

- The introduction should <u>not be</u>
 - Too broad or vague
 - More then 2 pages

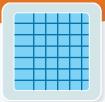


Paper Structure Methodology

- Problem formulation and the processes used to solve the problem, prove or disprove the hypothesis
- Use illustrations to clarify ideas, support conclusions:

Tables

Present representative data or when exact values are important to show



Figures

Quickly show ideas/conclusions that would require detailed explanations



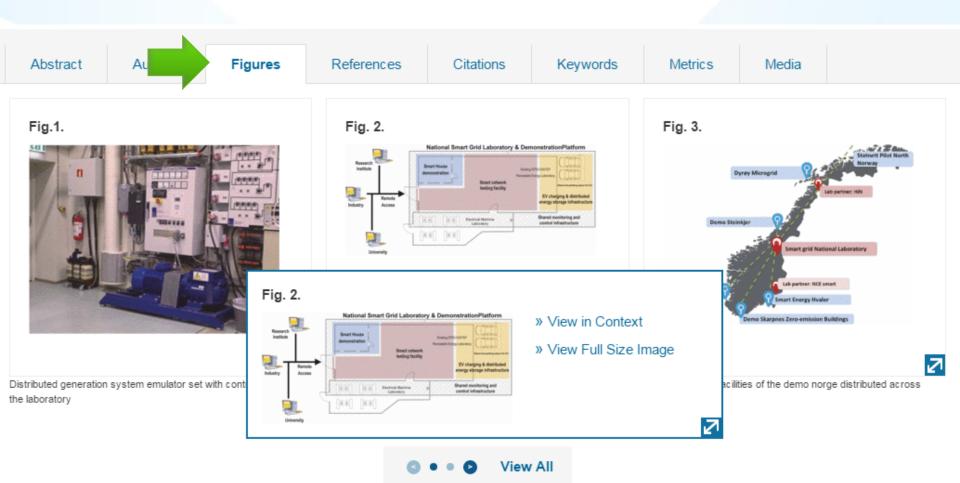
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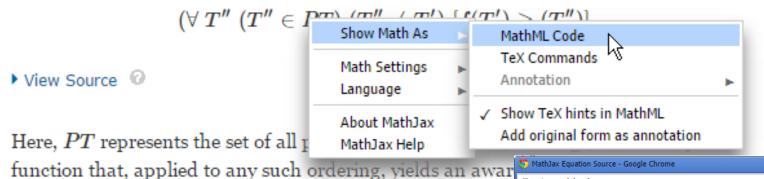


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Given: T , a test suite; PT , the set of permutations of T ; f , a function from PT to the real numbers.

Problem: Find $T' \in PT$ such that



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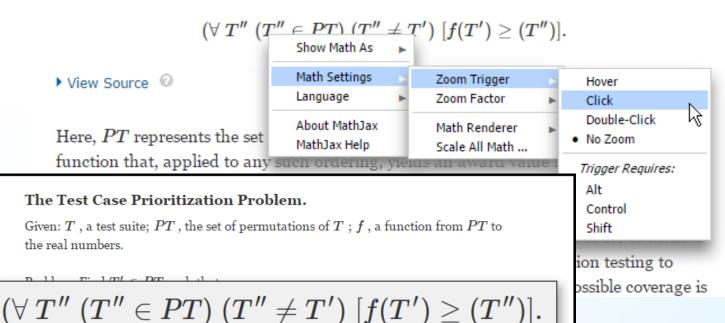
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The Test Case Prioritization Problem.

Given: T , a test suite; PT , the set of permutations of T ; f , a function from PT to the real numbers.

Problem: Find $T' \in PT$ such that

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Here, PT represents the set of all possible prioritizations (orderings) of T and f is a function that, applied to any such ordering, yields an award value for that ordering.

Paper Structure Results/discussion

Demonstrate that you solved the problem or made significant advances

Results: Summarized Data

- Should be clear and concise
- Use figures or tables with narrative to illustrate findings

Discussion: Interprets the Results

- Why your research offers a new solution
- Acknowledge any limitations

the SC algorithm over the whole range of w values increase to 3-4 K, except for the TIGR: to database, with an RMSE of 2 K. This last result is explained by the w distribution, which is biased toward low values of w in this database. When only atmospheric profiles with to values lower than S g - cm - 2 are selected, the SC algorithm provides RMS around 1.5 K, with almost equal values of bias and standard deviation, around 1 K in both cases (with a negative bias, thus the SC underestimates the LST). In contrast, when only we values higher than 3 g - cm⁻² are considered, the SC algorithm. provides RMSEs higher than 5 K. In these cases, it is preferable to calculate the atmospheric functions of the SC algorithm directly from (3) rather than approximating them by a polynomial fit approach as given by (4).

V. DISCUSSION AND CONCLUSION The two Landsat-S TIR bands allow the intercomparison

of two LST retrieval methods based on different physical such as the SC (only one TIR band required) fams (two TIR bands required). Direct inversion e transfer equation, which can be considered orithm, is assumed to be a "ground-truth" **Discussion** and L_d) is accurate enough. The SC algoin this letter is a continuation of the previous SC veloped for Landsat-4 and Landsat-5 TM sensors, ne ETM+ sensor on board the Landsat-7 platform [9], and it could be used to generate consistent LST products from the historical Landsat data using a single algorithm. An advantage of the SC algorithm is that, apart from surface emissivity, only water vapor content is required as input. However, it is expected that errors on LST become unacceptable for high water upper contents (e.g., > 3 g \cdot cm⁻²). This problem can be purify solved by computing the atmospheric functions directly from τ , L_{∞} , and $L_{\mathcal{L}}$ values [see (5)], or also by including air temperature as input [15]. A main advantage of the SW algorithm is that it performs well over global conditions and, thus, a wide range of water vapor values; and that it only requires water vapor as input (apart from surface emissivity at the two TIR bands). However, the SW algorithm can be only applied to the new Landant-S TIRS data, since previous TM/ETM sensors only had one TIR band.

The LST algorithms presented in this letter were tested with simulated data sets obtained for a variety of global atmospheric conditions and surface emissivities. The results showed RMSE values of typically less than 1.5 K, although for the SC algorithm, this accuracy is only achieved for w values below 9 g - cm⁻². Algorithm teeting also showed that the SW errors are lower than the SC errors for increasing water vapor, and vice versa, as demonstrated in the simulation study presented in Sobrino and Jiménez-Muñoz [18]. Although an extensive validation exercise from in sits measurements is required to assess the performance of the two LST algorithms, the results obtained for the simulated data, the sensitivity analysis, as well as the previous findings for algorithms with the same mothemotical structure give confidence in the algorithm accuracies

Results

[4] VI. Nastas and M. Anderson. "Advances in thermal infrared negative sensing for land surface modeling," Agric. Porest Maleorol., vol. 149, no. 12,

pp. 2073-2081, Dec. 2009.

[3] X.-L. Li, R.-H. Timp, H. Wu, H. Ren, G. Yin, Z. Whn, I. F. Trign, and I. A. Sobrino, "Satellite-derived land surface temperature: Connect. status and perspectives," Serects Sens. Environ., vol. 151, pp. 14-57,

[8] Z.-L. Li, H. Wu, N. Wang, S. Qiu, J. A. Sobrino, Z. Wan, R.-H. Tang, and G. Yan, "Land surface emissivity retrieval from schellin data," Int. J. Remote Sear., vol. 54, no. 9110, pp. 5064-5127, 2015.

[7] A. M. Miko, "Three decades of Landact instruments," Photo

 [7] A. N. Stein, I rive decides of Limited materials, Poccognition and Remote Sease, vol. 62, no. 7, pp. 659-652, Jul. 1997.
 [8] S. A. Eurel, J. R. Schett, F. D. Pallaconi, D. L. Helder, S. S. Hook, R. L. Markhorn, G. Chandler, and E. M. O'Donnell, "Londout TM and ETM+ thermal band calibration," Gas. J. Sewaris Sess., vol. 29, no. 2, pp. 141–152, 2005. [9] N. C. Resinac-Marico, J. Cristifoul, J. A. Sobrino, G. Shria, M. Ninyamia

and X. Poss, "Revision of the single-channel algorithm for land surface temperature retrieval from Lundar thermal-inflated data," IEEE Trans.

General Service Serv., vol. 47, no. 1, pp. 219–349, lbn. 2009.

[10] L. M. McMülle, "Estimation of sea surface temperatures from two infrared window measurements with different absorption," J. Geophys. Serv., vol. 90, no. 34, pp. 5113-5117, 1975. [11] J. A. Schrino, Z.-L. Li, M. P. Stoll, and E. Backer, "Multi-channel and

multi-angle algorithms for setimating sea and land surface temperature with ATSR data," Int. J. Remote Sens., vol. 17, no. 11, pp. 2089-0114,

(M.) Traillac-Marion and J. A. Sobrino, "Spih-window conflicients for land surface temperature retrieval from low-custorion thermal infrared sensors," IEEE Generi. Servote Serv. Lett., vol. 5, no. 4, pp. 806–808, Oct. 2008.

[17] A. Back, G. R. Anderson, R. K. Asharya, J. R. Chetrynd, L. S. Bernetsin, E. R. Shetle, M. W. Mothers, and S. M. Adiso-Golden, MODITRAWA Direr's Moreaul. Homsonn AFE, MA, USA: Air Potce Res. Lab., 1999. [14] A. M. Buldridge, S. J. Hook, C. I. Grove, and G. Rivera, "The ASTER.

spectral Fibrary variation 2.0," Semante Steat. Electron., vol. 113, no. 4, pp. 711-715, Apr. 2009.
[15] N. Criseffeal, J. C. Jimánan-Medice, J. A. Sebrino, M. Ninyerola, and

[27] C. Gerrento, C. Communication in Standard Services, Services and Association and Services and Service C. Dalaci, R. Dengoni, M. Paeries, A. f. Geer, L. Halmberger S. R. Healy, H. Haraboch, E. V. Hölm, L. Indones, R. Kullberg, M. Kobler M. Motricandi, A. F. McNally, E. M. Mange-Sunz, J.-f. Monorette, R.-K. Fark, C. Peuber, P. de Rossey, C. Toroloto, J.-N. Thépout, and F. Viter, "The ERA-Inferior remarks in Configuration and performance of the data assimilation system," Q. J. R. Material, Soc., vol. 137, no. 656, pp. 555-697, 2011.
C. Marter, C. Durfer-Alarofe, J. C. Resinez-Minfox, and J. A. Sobrino

"Global Atmospheric Profiles from Recoulysis Information (GAFRI): A new detaset for forward simulations in the thermal infrared region, "MEE Press. George, Revote Seer., 2014, submitted for publication.

[15] J. A. Sobrino and J. C. Renina-Multice, "Land surface temperature settlevel from thermal infrared data: An assessment in the content of the surface processes and scorystem changes through response analysis (SPECTEA) mission," J. Geophys. Sec., vol. 110, no. D06, p. D1608,



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We then have

$$(P_t^{a,+} + P_t^{a,-})^2 - (P_t^{a,+} - P_t^{a,-})^2 + 4P_t^{a,+}P_t^{a,-}$$

 $< (\hat{P}_t^{a,+} - \hat{P}_t^{a,-})^2 + 4\hat{P}_t^{a,+}\hat{P}_t^{a,-}$
 $- (\hat{P}_t^{a,+} + \hat{P}_t^{a,-})^2.$ (32)

Since $P_i^{h,+} - P_i^{h,-} = P_i^{h,+} - P_i^{h,-}$, we then have $P_i^{h,+} < P_i^{h,+}$, and $P_i^{h,-} < P_i^{h,-}$. Because the operational cost is an increasing function of $\{P_i^{h,+}, P_i^{h,-}\}$, we obtain that

$$c_{n/m}(P_t^{s,+}, P_t^{s,-}) < c_{n/m}(\hat{P}_t^{s,+}, \hat{P}_t^{s,-}).$$
 (33)

Therefore the optimal pair $\{P_i^{h,+},P_i^{h,-}\}$ must satisfy that $P_i^{h,+}P_i^{h,-}=0$, i.e., only one of $P_i^{h,+},P_i^{h,-}$ can be non-zero.

REFERENCES

- [1] "Renewables: Energy You can Count on," Tech. Rep. Union of Concerned Scientists, 2013.
 S. Collier, "Ten street to a smarter and "WWW led. April May, vol. 16.
- so. 2, pp. 62-68, 2010.
- [3] J. A. Turnet, "A realizable mn-awable-energy future," Sci., vol. 283, no. 5428, pp. 687–689, 1999.
- [4] "Exploration of High-Pesetration Renewable Electricity Futures," Tech. Rep. National Renewable Energy Lab., 2012.
- [5] T. Wiedmann and J. Minn, A Digitation of Corbon Footprine. Hasp-page, NY, USA: Nova Science, 2008.
- [5] J. Carracco, L. Franquelo, J. Bialastewicz, E. Galvae, R. Guisado, M. Posts, J. Leou, and N. Moreno-Alfonso, "Power-electronic systems for the grid integration of renewable energy sources: A survey," IEEE Trans. Ind. Electron., vol. 53, no. 4, pp. 1902–1916, 2006.
- Trans. Ind. Allicoron., vol. 53, no. 4, pp. 1002–1016, 2006.

 [7] H. Brahlm, A. Ilinoa, and J. Perron, "Desigy stronge systems —characteristics and comparisons," Renewable Sunstituable Energy Sen., vol. 12, no. 5, pp. 1221–1250, 2000.
- [8] J. Clarcia-Conzalez, R. de la Moela, L. Nazine, and A. Gonzalez, "Sto-chastic joint optimization of wind generation and pumped-storage units in an electricity marker," IEEE Trans. Power Syst., vol. 23, no. 2, pp. 460–468, 2008.
- [9] T. D. Nguyen, K.-J. Tamp, S. Zhang, and T. D. Nguyen, "On the moding and control of a novel flywhool energy storage system," in Proc. IEEE, 2010, pp. 1395–1401.
 Zhoe, T. Bhatischarya, D. Tran, T. Siew, and A. Khambadkone,
 - Chou, T. Bhattacharya, D. Tran, T. Siew, and A. Khambadtone, e-posite energy storage system involving battery and ultracapacitor ratio energy management in microgrid applications," IEEE Conference, vol. 26, no. 3, pp. 923–930, 2011.
 - Clariron, vol. 26, no. 3, pp. 923–930, 2011.

 and J. F. Miller, "Key challenges and roomt progress in
 A, fiel cells, and Sydrogen tomage for clean energy systems,"
 over Sources, vol. 193, no. 1, pp. 73–80, 2000.
 acros and D. Iridal, "Energy Sorage and its use with intermitates
 exchals energy," ISUE Trans. Beargy Conversion, vol. 19, no. 2, pp.
 41–448, 2034.
- [13] K. O. Vosburgh, "Compressed air energy storage," J. Shergo, vol. 2, no. 2, pp. 106–112, 1978.
- [14] C. Abbey and G. Josa, "Supercapacitor energy storage for wind energy applications," *IEEE Trans. Ind. Appl.*, vol. 43, no. 3, pp. 769–776, 2007.
 [15] P. Brown, J. P. Loose, and M. Matos, "Optimization of purposed storage."
- [15] P. Brown, J. P. Lopen, and M. Matos, "Optimization of pumped storage capacity in an isolated power system with large renewable penetration," *IEEE Trans. Power Syst.*, vol. 23, no. 2, pp. 523–531, 2008.
- [16] C. Abbey and G. Joos, "A stochastic optimization approach to rating of energy storage systems in wind-dissell isolated grids," IEEE Trans. Preser Syst., vol. 24, no. 1, pp. 418–426, 2009.
- [17] Y. Zhang, N. Gatin, and G. Giannakin, "Robust energy management for microgride with high-penetration renewables," *IEEE Trans. Sus*tainable Energy, vol. 77, no. 99, pp. 1–10, 2013.

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- [13] S. Boyd, N. Parlich, E. Chu, B. Peleato, and J. Eclorieiz, "Distributed opterization and statistical learning via the alternating direction method of realispliers," Foundations Trends Mach. Learning, vol. 3, no. 1, pp. 1–122, 2010.
- [19] G. Calaffore and M. Campi, "The someto approach to robust control design," *IEEE Trans. Autom. Contr.*, vol. 51, no. 5, pp. 742–752, 2006.
 [20] A. Shapiro, D. Destribeva, and A. Russcrynski, Lectures on Stochastic Programming: Modeling and Theory. Philadelphia, NJ, USA: SIAM.
- [21] Y. Zhang, N. Gainis, and G. Giannakis, "Risk-constrained energy management with multiple wind farms," in Proc. IEEE PISS ISCIT, Feb.
- 2013, pp. 1-6.
 [22] Y. Zhang, N. Gatsis, V. Kekaton, and G. Giannsalda, "Risk-aware management of distributed energy resources," in Proc. Set. Conf. Digital
- Signal Process, Int. 2013, pp. 1–5.

 [23] P. Yang and A. Neboni, "Hybrid energy storage and generation planning with large reservable penetration," in IEEE Int. Morbibop Com-
- patat Adv. Afrikit-Sessor Adaptive Process., Doc. 2013, pp. 1-4.
 [24] EPKI, "Electricity Bassgy Storage Technology Options: A White Paper Primer on Applications, Costs, and Henefits," Tech. Rep. EPKI, Palo Alto, CA, USA, 2010.
- [25] National Solar Radiation Data Base, [Online]. Available: http://redc
- nest gavisolaciold data/rands/ [26] S. Witcox, National Solar Radiation Database 1991 – 2010 Update User's Manual, 2012.
- [27] EFRI, "Renewable Energy Technical Assessment Guide TAG-RE-2006," Tech. Rep. EFRI, Pulo Alto, CA, USA, 2007.
 [28] EFCOT Nearly Load Data Archive [Online]. Available: http://www.
- [28] ERCOT Hourly Load Data Archive [Online]. Available: http://www.scot.com/gridinfo/load/load_bia/
 [29] M. Onet and S. Bord, CVP. Mediah Software for Distributed Convention.
- [29] M. Uraci and S. Doyd, C.F.C. Mental Seyware for Exceptioned Control Programming, Version 2.0 Beta 2012 [Online]. Available: http://cviccom/eve
- [30] "MISO Daily Report," 2011, Electric Power Markett: Midwest (MISO), PERC [Online]. Available: http://www.ferr.gov/market-over-sight/mkt-electric/midwest/miso-archives.asp
- [31] "CAISO Daily Report," 2011, Electric Power Markets: California (CAISO), PERC [Online]. Available: http://www.ferc.gov/market-oversight/mik/-electric/california/calso-archives.asp



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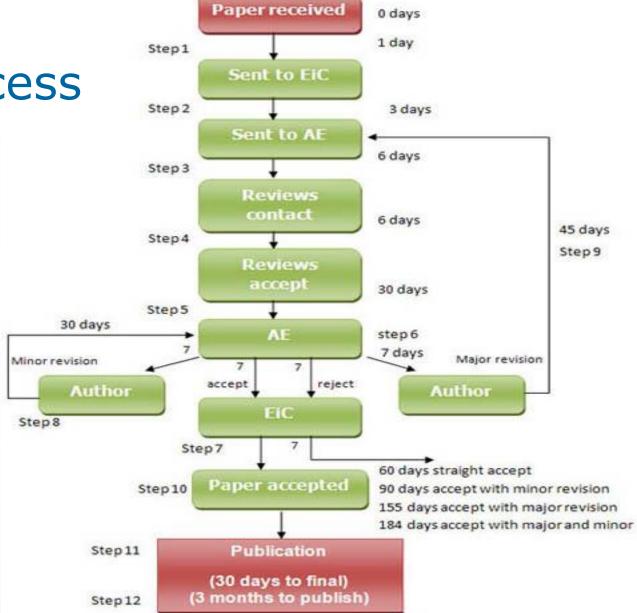
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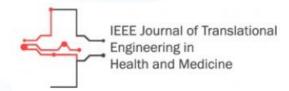


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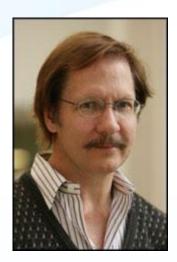
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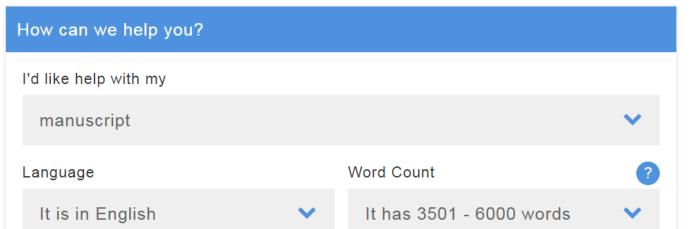


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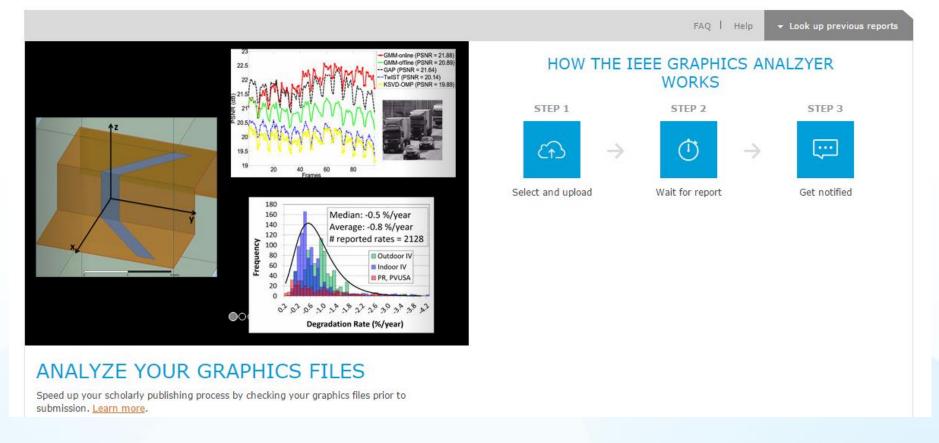
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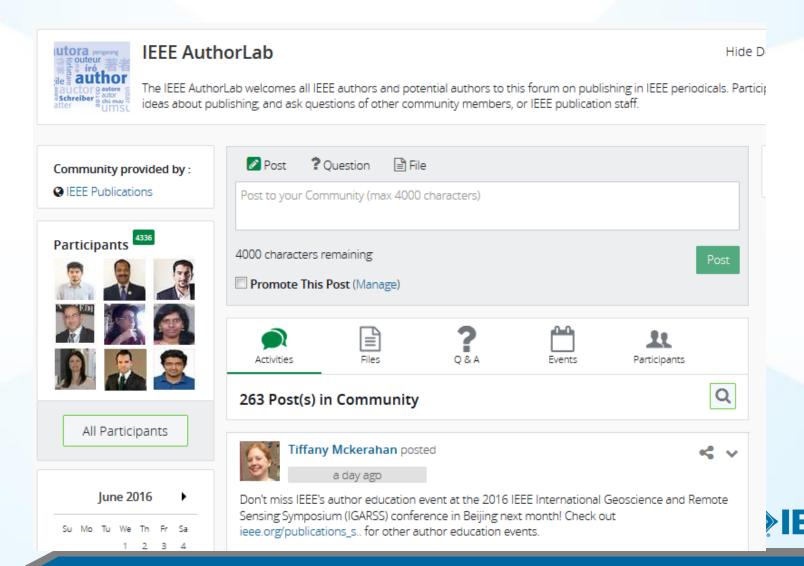








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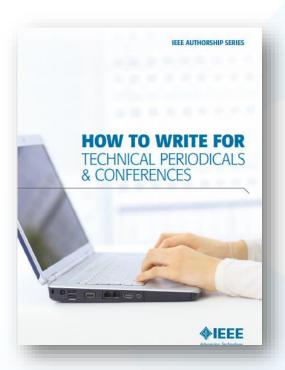
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